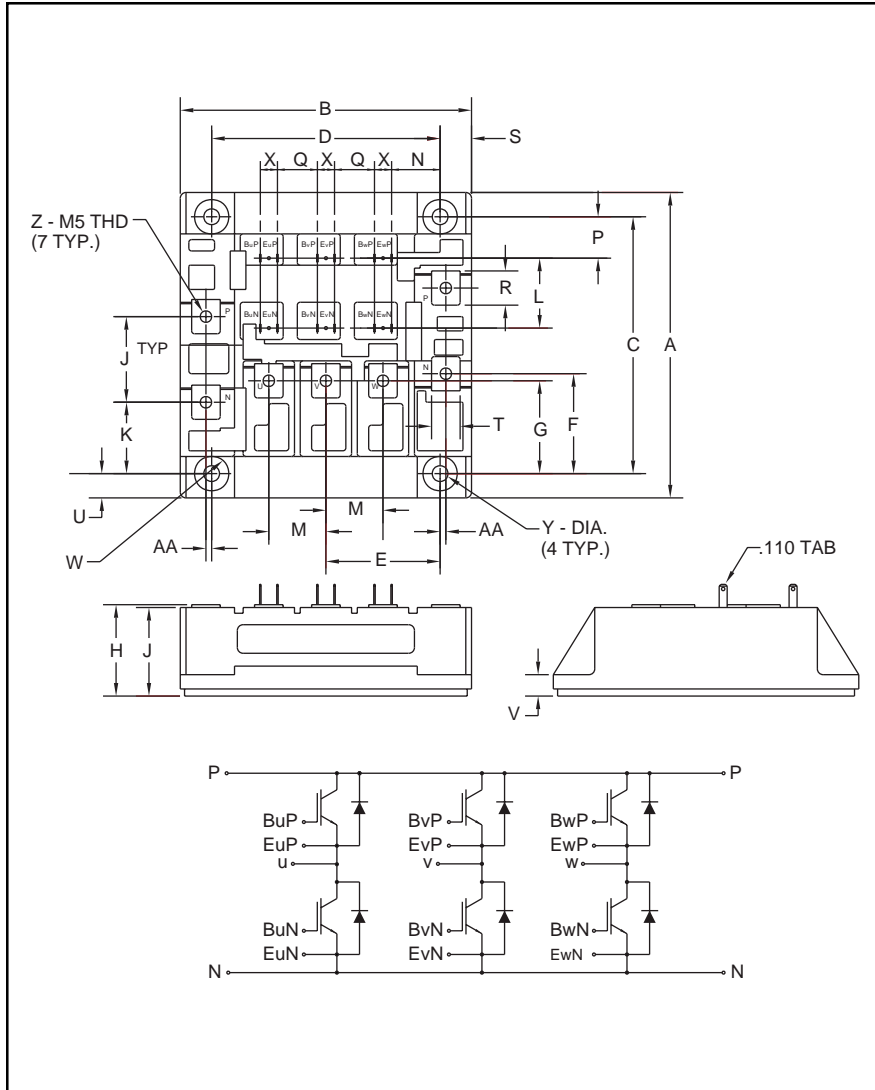


Six-IGBT IGBTMOD™ H-Series Module 75 Amperes/1400 Volts



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of six IGBT Transistors in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery (135ns) Free-Wheel Diode
- High Frequency Operation (20-25kHz)
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies
- Laser Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM75TF-28H is a 1400V (V_{CES}), 75 Ampere Six-IGBT IGBTMOD™ Power Module.

Outline Drawing and Circuit Diagram

| Dimensions | Inches | Millimeters |
|------------|-----------|-------------|
| A | 4.21 | 107.0 |
| B | 4.02 | 102.0 |
| C | 3.54±0.01 | 90.0±0.25 |
| D | 3.15±0.01 | 80.0±0.25 |
| E | 1.57 | 40.0 |
| F | 1.38 | 35.0 |
| G | 1.28 | 32.5 |
| H | 1.26 Max. | 32.0 Max |
| J | 1.18 | 30.0 |
| K | 0.98 | 25.0 |
| L | 0.96 | 24.5 |
| M | 0.79 | 20.0 |
| N | 0.67 | 17.0 |

| Dimensions | Inches | Millimeters |
|------------|-----------|-------------|
| P | 0.57 | 14.5 |
| Q | 0.55 | 14.0 |
| R | 0.47 | 12.0 |
| S | 0.43 | 11.0 |
| T | 0.39 | 10.0 |
| U | 0.33 | 8.5 |
| V | 0.30 | 7.5 |
| W | 0.24 Rad. | Rad. 6.0 |
| X | 0.24 | 6.0 |
| Y | 0.22 | 5.5 |
| Z | M5 Metric | M5 |
| AA | 0.08 | 2.0 |

| Type | Current Rating Amperes | V_{CES} Volts (x 50) |
|------|---------------------------|---------------------------|
| CM | 75 | 28 |

CM75TF-28H

Six-IGBT IGBTMOD™ H-Series Module

75 Amperes/1400 Volts

Absolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | CM75TF-28H | Units |
|---|-----------|------------|------------------|
| Junction Temperature | T_j | -40 to 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -40 to 125 | $^\circ\text{C}$ |
| Collector-Emitter Voltage (G-E-SHORT) | V_{CES} | 1400 | Volts |
| Gate-Emitter Voltage (C-E-SHORT) | V_{GES} | ± 20 | Volts |
| Collector Current | I_C | 75 | Amperes |
| Peak Collector Current | I_{CM} | 150* | Amperes |
| Diode Forward Current | I_{EC} | 75 | Amperes |
| Diode Forward Pulse Current | I_{ECM} | 150* | Amperes |
| Power Dissipation | P_d | 600 | Watts |
| Max. Mounting Torque M5 Terminal Screws | - | 17 | in-lb |
| Max. Mounting Torque M5 Mounting Screws | - | 17 | in-lb |
| Module Weight (Typical) | - | 830 | Grams |
| V Isolation | V_{RMS} | 2500 | Volts |

* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|---------------|--|------|------|-------|---------------|
| Collector-Cutoff Current | I_{CES} | $V_{CE} = V_{CES}, V_{GE} = 0V$ | - | - | 1.0 | mA |
| Gate Leakage Current | I_{GES} | $V_{GE} = V_{GES}, V_{CE} = 0V$ | - | - | 0.5 | μA |
| Gate-Emitter Threshold Voltage | $V_{GE(th)}$ | $I_C = 7.5\text{mA}, V_{CE} = 10V$ | 5.0 | 6.5 | 8.0 | Volts |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_C = 75A, V_{GE} = 15V$ | - | 3.1 | 4.2** | Volts |
| | | $I_C = 75A, V_{GE} = 15V, T_j = 150^\circ\text{C}$ | - | 2.95 | - | Volts |
| Total Gate Charge | Q_G | $V_{CC} = 800V, I_C = 75A, V_{GS} = 15V$ | - | 383 | - | nC |
| Diode Forward Voltage | V_{FM} | $I_E = 75A, V_{GS} = 0V$ | - | - | 3.8 | Volts |

** Pulse width and repetition rate should be such that device junction temperature rise is negligible.

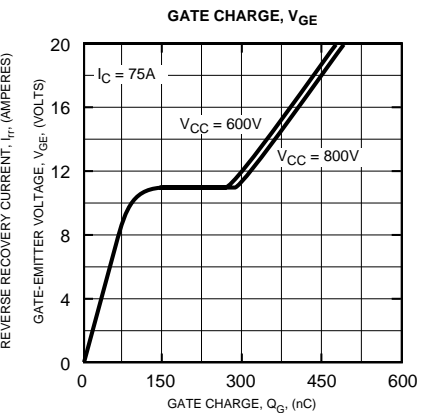
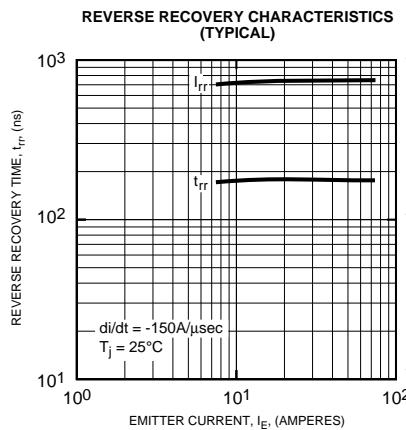
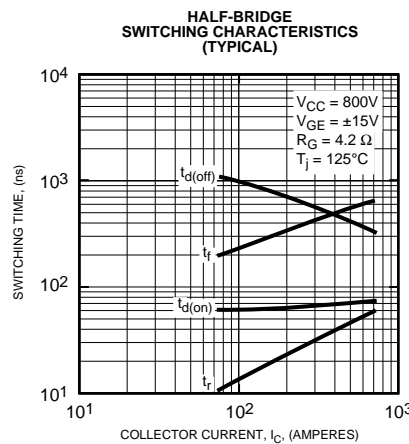
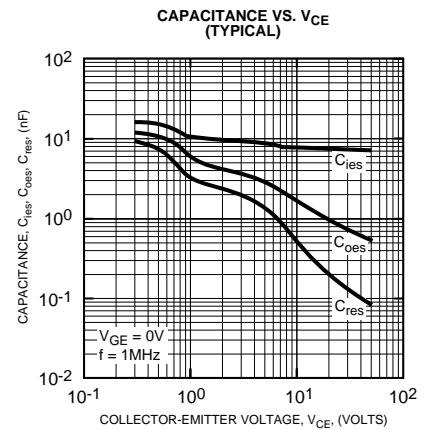
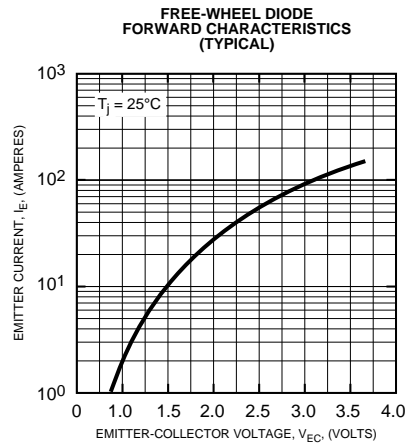
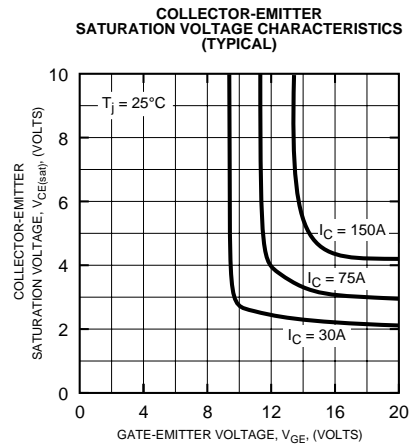
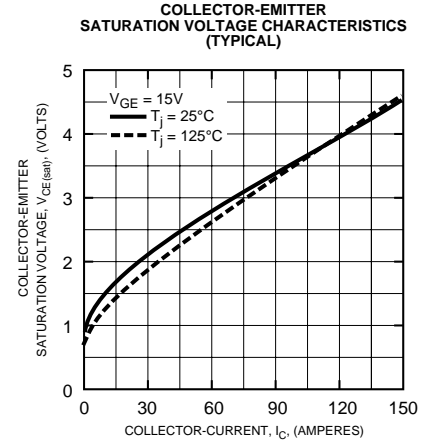
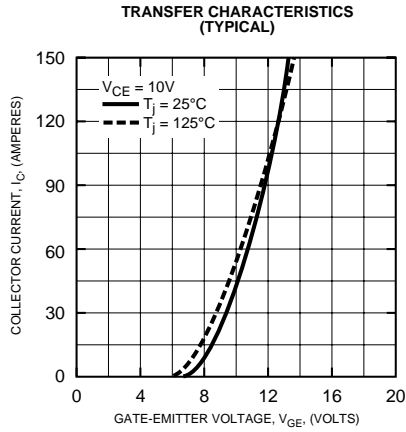
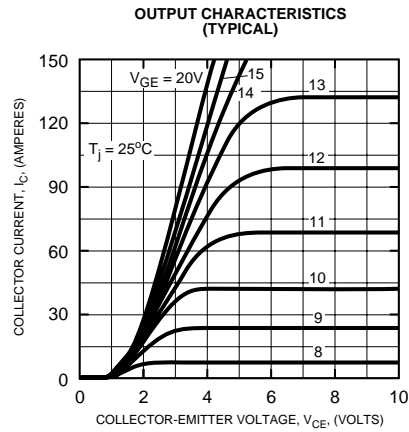
Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|-------------------------------|---------------------|--|------|------|------|---------------|
| Input Capacitance | C_{ies} | | - | - | 15 | nF |
| Output Capacitance | C_{oes} | $V_{GE} = 0V, V_{CE} = 10V, f = 1\text{MHz}$ | - | - | 5.3 | nF |
| Reverse Transfer Capacitance | C_{res} | | - | - | 3 | nF |
| Resistive | Turn-on Delay Time | $t_{d(on)}$ | - | - | 150 | ns |
| Load | Rise Time | t_r | - | - | 350 | ns |
| Switch | Turn-off Delay Time | $t_{d(off)}$ | - | - | 250 | ns |
| | | | | | | |
| Diode Reverse Recovery Time | t_{rr} | $I_E = 75A, di_E/dt = -150A/\mu\text{s}$ | - | - | 300 | ns |
| Diode Reverse Recovery Charge | Q_{rr} | $I_E = 75A, di_E/dt = -150A/\mu\text{s}$ | - | 0.75 | - | μC |

Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|---------------|------------------------------------|------|------|-------|--------------------|
| Thermal Resistance, Junction to Case | $R_{th(j-c)}$ | Per IGBT | - | - | 0.21 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction to Case | $R_{th(j-c)}$ | Per FWDi | - | - | 0.47 | $^\circ\text{C/W}$ |
| Contact Thermal Resistance | $R_{th(c-f)}$ | Per Module, Thermal Grease Applied | - | - | 0.025 | $^\circ\text{C/W}$ |

CM75TF-28H
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